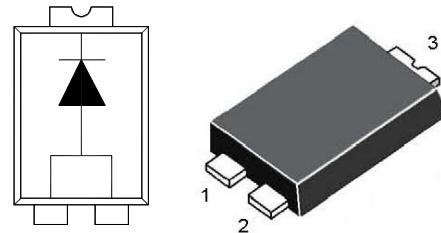


SDB0540-HAF

Surface Mount Schottky Barrier Rectifier

Features

- Low forward voltage drop
- Halogen and Antimony Free(HAF), RoHS compliant



TO-277 Plastic Package

Absolute Maximum Ratings ($T_a = 25^\circ\text{C}$)

| Parameter | Symbol | Value | Unit |
|--|-----------------|---------------|--------------------|
| Working Peak Reverse Voltage | V_{RWM} | 40 | V |
| Repetitive Peak Reverse Voltage | V_{RRM} | 40 | V |
| Reverse Voltage | V_R | 40 | V |
| RMS Reverse Voltage | $V_{R(RMS)}$ | 28 | V |
| Average Rectified Output Current | I_O | 5 | A |
| Non-Repetitive Peak Forward Surge Current ($t = 8.3 \text{ ms}$) | I_{FSM} | 120 | A |
| Typical Thermal Resistance, Junction to Ambient ¹⁾ | $R_{\theta JA}$ | 95 | $^\circ\text{C/W}$ |
| Typical Thermal Resistance, Junction to Ambient ²⁾ | $R_{\theta JA}$ | 70 | $^\circ\text{C/W}$ |
| Typical Thermal Resistance, Junction to Ambient ³⁾ | $R_{\theta JC}$ | 50 | $^\circ\text{C/W}$ |
| Operating and Storage Temperature Range | $T_J T_{stg}$ | - 55 to + 150 | $^\circ\text{C}$ |

¹⁾ FR-4 PCB, 2oz. Copper, minimum recommended pad layout.

²⁾ Polyimide PCB, 2oz. Copper, minimum recommended pad layout.

³⁾ Polyimide PCB, 2oz. Copper, cathode pad dimensions 9.4 mm x 7.2 mm, Anode pad dimensions 2.7 mm x 1.6 mm.

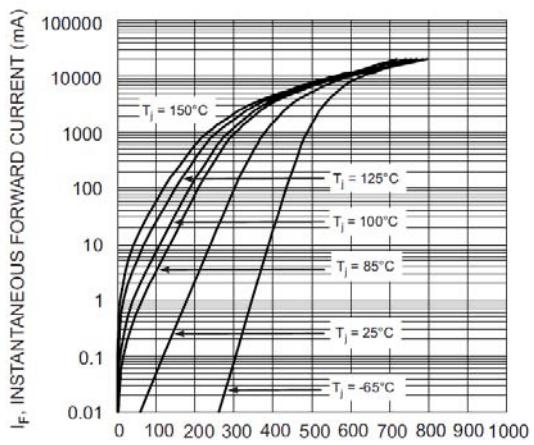
Characteristics at $T_a = 25^\circ\text{C}$

| Parameter | Symbol | Min. | Max. | Unit |
|---|----------|------------------|------------------------------|------|
| Reverse Breakdown Voltage at $I_R = 0.5 \text{ mA}$ | V_{BR} | 40 | - | V |
| Forward Voltage at $I_F = 5 \text{ A}, T_J = 25^\circ\text{C}$ at $I_F = 5 \text{ A}, T_J = 125^\circ\text{C}$ at $I_F = 10 \text{ A}, T_J = 25^\circ\text{C}$ at $I_F = 10 \text{ A}, T_J = 125^\circ\text{C}$ | V_F | - - - - | 0.52 0.47 0.65 0.59 | V |
| Reverse Current ³⁾ at $V_R = 40 \text{ V}, T_J = 25^\circ\text{C}$ at $V_R = 40 \text{ V}, T_J = 100^\circ\text{C}$ at $V_R = 40 \text{ V}, T_J = 125^\circ\text{C}$ | I_R | - - - | 0.3 20 40 | mA |

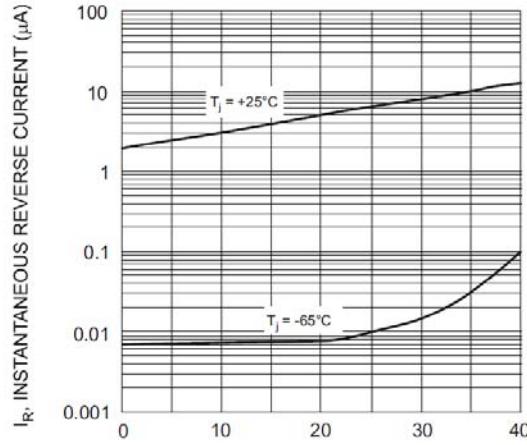
³⁾ Short duration pulse test used to minimize self-heating effect.

TOP DYNAMIC

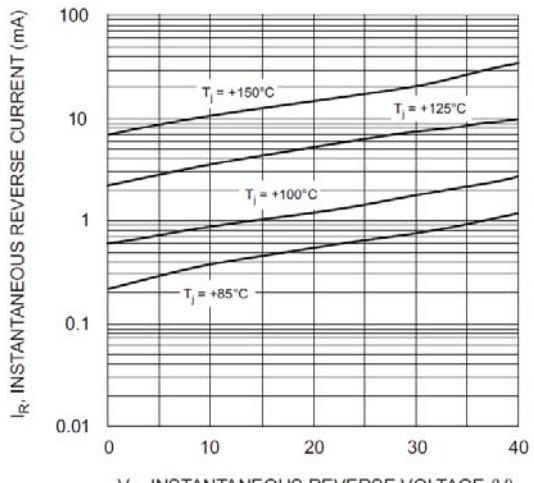
SDB0540-HAF



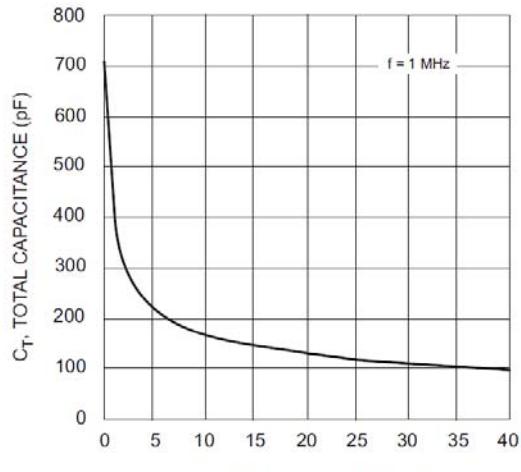
V_F , INSTANTANEOUS FORWARD VOLTAGE (mV)
Fig. 1 Typical Forward Characteristics



V_R , INSTANTANEOUS REVERSE VOLTAGE (V)
Fig. 2 Typical Reverse Characteristics



V_R , INSTANTANEOUS REVERSE VOLTAGE (V)
Fig. 3 Typical Reverse Characteristics

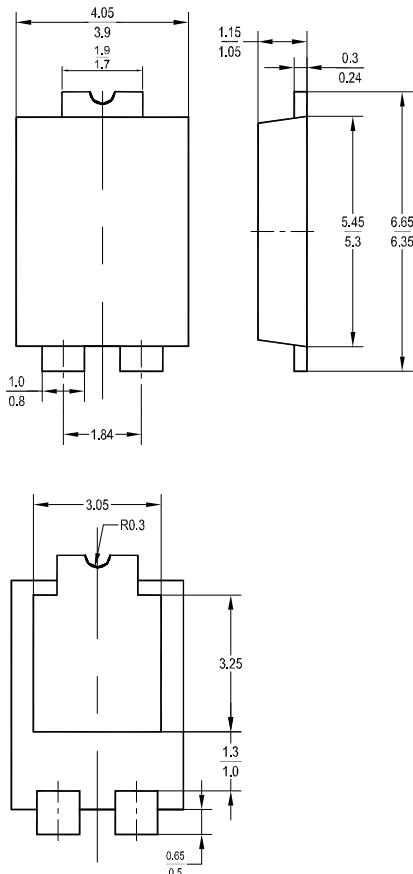


V_R , REVERSE VOLTAGE (V)
Fig. 4 Typical Total Capacitance vs. Reverse Voltage

TOP DYNAMIC

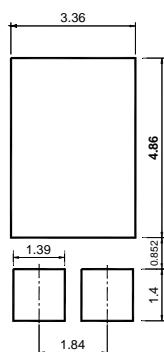
SDB0540-HAF

TO-277 PACKAGE OUTLINE



Dimensions in mm

Recommended Soldering Footprint



TO-277

Packing information

| Package | Tape Width (mm) | Pitch | | Reel Size | | Per Reel Packing Quantity |
|---------|--------------------|---------|---------------|-----------|------|---------------------------|
| | | mm | inch | mm | inch | |
| TO-277 | 12 | 4 ± 0.1 | 0.157 ± 0.004 | 330 | 13 | 5,000 |

TOP DYNAMIC